



## Industry 4.0 Based Smart Manufacturing Systems

Guest Editor:

**Prof. Dr. Tobias Meisen**

School of Electrical, Information  
and Media Engineering,  
University of Wuppertal, Rainer-  
Gruenter-Str. 21, D-42119  
Wuppertal, Germany

Deadline for manuscript  
submissions:

**closed (31 May 2021)**

### Message from the Guest Editor

Dear Colleagues,

In a traditional way, manufacturing means the engineering process of creating industrial products from raw materials using a variety of subtractive and additive methods. However, in recent years, the concept of manufacturing has drastically shifted. After the first wave of digitization, new and modernized technologies such as integrated sensors, advanced robotics, and artificial intelligence led to the so-called Smart Manufacturing as part of the fourth industrial revolution—often referred to as Industry 4.0.

In Smart Manufacturing, production tools are connected to constantly gather data, monitor production processes, and perform real-time optimization. Smart Manufacturing therefore includes not only data collection and processing, but also inferring from and reasoning about data by means of cognitive computing to improve the end product.

The aim of the edition “Industry 4.0-Based Smart Manufacturing Systems” is therefore to present new and innovative methods in which data can be better and more efficiently extracted, collected, processed, and finally used in Smart Manufacturing environments.





an Open Access Journal by MDPI

## Editor-in-Chief

**Prof. Dr. Giulio Nicola Cerullo**  
Dipartimento di Fisica,  
Politecnico di Milano, Piazza L.  
da Vinci 32, 20133 Milano, Italy

## Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

## Author Benefits

**Open Access:** free for readers, with article processing charges (APC) paid by authors or their institutions.

**High Visibility:** indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, Embase, CAPlus / SciFinder, and other databases.

**Journal Rank:** JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

## Contact Us

---

*Applied Sciences* Editorial Office  
MDPI, Grosspeteranlage 5  
4052 Basel, Switzerland

Tel: +41 61 683 77 34  
[www.mdpi.com](http://www.mdpi.com)

[mdpi.com/journal/applsci](http://mdpi.com/journal/applsci)  
[applsci@mdpi.com](mailto:applsci@mdpi.com)  
[X@Applsci](https://twitter.com/Applsci)